

**N-Ch MOSFET** 

# **General Description**

The WSF20N06 is the highest performance trench N-Ch MOSFET with extreme high cell density , which provide excellent RDSON and gate charge for most of the synchronous buck converter applications .

The WSF20N06 meet the RoHS and Green Product requirement.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

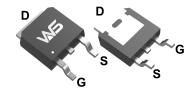
# **Product Summery**

| BVDSS | RDSON | ID  |
|-------|-------|-----|
| 60V   | 35mΩ  | 25A |

### **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- LCD/LED back light

# **TO-252 Pin Configuration**





# **Absolute Maximum Ratings**

| Symbol                                | Parameter  | Rating     | Units        |
|---------------------------------------|--|------------|--------------|
| $V_{DS}$                              | Drain-Source Voltage   | 60         | V            |
| $V_{GS}$                              | Gate-Source Voltage  | ±20        | V            |
| I <sub>D</sub> @T <sub>C</sub> =25℃   | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 25         | Α            |
| I <sub>D</sub> @T <sub>C</sub> =100°C | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 27         | А            |
| I <sub>D</sub> @T <sub>A</sub> =25℃   | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 8          | Α            |
| I <sub>D</sub> @T <sub>A</sub> =70°C  | Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup> | 10         | А            |
| I <sub>DM</sub>                       | Pulsed Drain Current <sup>2</sup>                            | 100        | А            |
| EAS                                   | Single Pulse Avalanche Energy <sup>3</sup>                   | 38         | mJ           |
| I <sub>AS</sub>                       | Avalanche Current  | 14         | Α            |
| P <sub>D</sub> @T <sub>C</sub> =25°C  | Total Power Dissipation <sup>4</sup>                         | 35         | W            |
| P <sub>D</sub> @T <sub>A</sub> =25℃   | Total Power Dissipation <sup>4</sup>                         | 3.3        | W            |
| T <sub>STG</sub>                      | Storage Temperature Range                                    | -55 to 175 | °C           |
| $T_J$                                 | Operating Junction Temperature Range -55 to 175              |            | $^{\circ}$ C |

#### **Thermal Data**

| Symbol           | Parameter  | Тур. | Max. | Unit |
|------------------|--|------|------|------|
| R <sub>0JA</sub> | Thermal Resistance Junction-Ambient <sup>1</sup> |      | 75   | °C/W |
| $R_{	heta JC}$   | Thermal Resistance Junction-Case <sup>1</sup>    |      | 3    | °C/W |



# Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

| Symbol                               | Parameter                                      | Conditions  | Min. | Тур.  | Max. | Unit |
|--------------------------------------|--|---|------|-------|------|------|
| BV <sub>DSS</sub>                    | Drain-Source Breakdown Voltage                 | $V_{GS}$ =0 $V$ , $I_D$ =250 $u$ A                                | 60   |       |      | V    |
| $\triangle BV_{DSS}/\triangle T_{J}$ | BV <sub>DSS</sub> Temperature Coefficient      | Reference to 25 $^{\circ}{\mathbb C}$ , ID=1mA                    |      | 0.057 |      | V/°C |
| D                                    | Static Drain-Source On-Resistance <sup>2</sup> | V <sub>GS</sub> =10V , I <sub>D</sub> =16A                        |      | 35    | 45   | 0    |
| $R_{DS(ON)}$                         |  | $V_{GS}$ =5 $V$ , $I_D$ =8 $A$                                    |      | 40    | 50   | mΩ   |
| $V_{GS(th)}$                         | Gate Threshold Voltage                         | \/ -\/   -250uA   | 1.0  | 1.6   | 2.5  | V    |
| $\triangle V_{GS(th)}$               | V <sub>GS(th)</sub> Temperature Coefficient    | $V_{GS}=V_{DS}$ , $I_D=250uA$                                     |      | -5.68 |      | mV/℃ |
|                                      | Drain Source Leakage Current                   | $V_{DS}$ =60V , $V_{GS}$ =0V , $T_J$ =25 $^{\circ}$ C             |      |       | 1    | · uA |
| I <sub>DSS</sub>                     | Drain-Source Leakage Current                   | $V_{DS}$ =60V , $V_{GS}$ =0V , $T_J$ =125 $^{\circ}$ C            |      |       | 100  | uA   |
| I <sub>GSS</sub>                     | Gate-Source Leakage Current                    | $V_{GS}$ = $\pm 16V$ , $V_{DS}$ = $0V$                            |      |       | ±10  | nA   |
| gfs                                  | Forward Transconductance                       | V <sub>DS</sub> =25V , I <sub>D</sub> =18A                        |      | 25    |      | S    |
| Rg                                   | Gate Resistance                                | V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz                |      | 1.7   | 3.4  | Ω    |
| $Q_g$                                | Total Gate Charge (4.5V)                       | V <sub>DS</sub> =30V , V <sub>GS</sub> =10V , I <sub>D</sub> =18A |      | 20    |      |      |
| $Q_{gs}$                             | Gate-Source Charge                             |   |      | 7     |      | nC   |
| $Q_{gd}$                             | Gate-Drain Charge                              |   |      | 5     |      |      |
| T <sub>d(on)</sub>                   | Turn-On Delay Time                             |   |      | 18    |      |      |
| Tr                                   | Rise Time                                      | $V_{DD}$ =30V , $V_{GS}$ =10V , $R_G$ =6.8 $\Omega$ , $I_D$ =1A   |      | 15    |      | no   |
| T <sub>d(off)</sub>                  | Turn-Off Delay Time                            |   |      | 60    |      | ns   |
| T <sub>f</sub>                       | Fall Time                                      |   |      | 31    |      |      |
| Ciss                                 | Input Capacitance                              | V <sub>DS</sub> =30V , V <sub>GS</sub> =0V , f=1MHz               |      | 650   |      |      |
| C <sub>oss</sub>                     | Output Capacitance                             |   |      | 95    |      | pF   |
| C <sub>rss</sub>                     | Reverse Transfer Capacitance                   |   |      | 60    |      |      |

# **Guaranteed Avalanche Characteristics**

| Symbol | Parameter                                  | Conditions  | Min. | Тур. | Max. | Unit |
|--------|--|---|------|------|------|------|
| EAS    | Single Pulse Avalanche Energy <sup>5</sup> | V <sub>DD</sub> =25V , L=0.1mH , I <sub>AS</sub> =15A | 19   |      |      | mJ   |

### **Diode Characteristics**

| Symbol          | Parameter                                | Conditions  | Min. | Тур. | Max. | Unit |
|-----------------|--|---|------|------|------|------|
| Is              | Continuous Source Current <sup>1,6</sup> | V <sub>G</sub> =V <sub>D</sub> =0V , Force Current              |      |      | 25   | Α    |
| I <sub>SM</sub> | Pulsed Source Current <sup>2,6</sup>     |   |      |      | 75   | Α    |
| V <sub>SD</sub> | Diode Forward Voltage <sup>2</sup>       | V <sub>GS</sub> =0V , I <sub>S</sub> =20A , T <sub>J</sub> =25℃ |      |      | 1.3  | V    |
| t <sub>rr</sub> | Reverse Recovery Time                    | IF=20A ,dI/dt=100A/μs,TJ=25℃                                    |      | 65   |      | nS   |
| Q <sub>rr</sub> | Reverse Recovery Charge                  |   |      | 85   |      | nC   |

#### Note:

- 1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper,t<10sec.
- 2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%
- 3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V, $V_{GS}$ =10V,L=0.1mH, $I_{AS}$ =15A
- 4. The power dissipation is limited by 150 °C junction temperature
- 5.The Min. value is 100% EAS tested guarantee.
- 6. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.



# **Typical Characteristics**

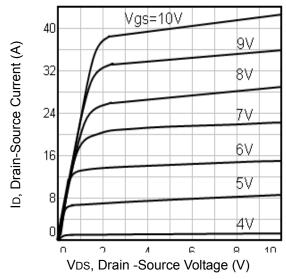


Fig1. Typical Output Characteristics

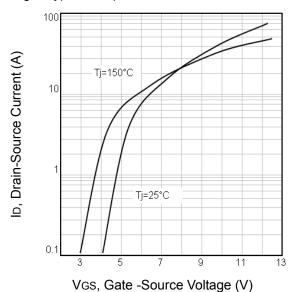


Fig3. Typical Transfer Characteristics

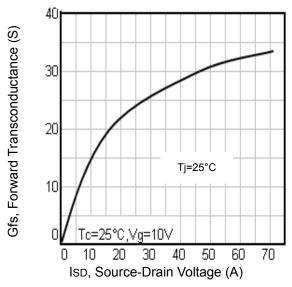
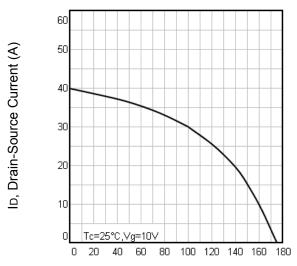


Fig5. Typical Forward Transconductance Vs. Drain Current



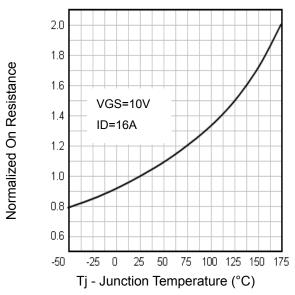


Fig4. Normalized On-Resistance Vs. Temperature

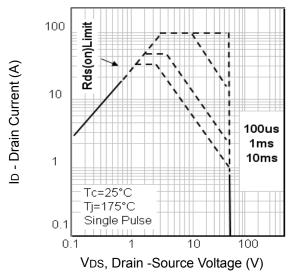


Fig6. Maximum Safe Operating Area



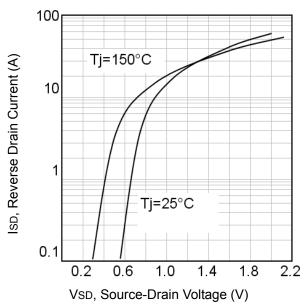


Fig7. Typical Source-Drain Diode Forward Voltage

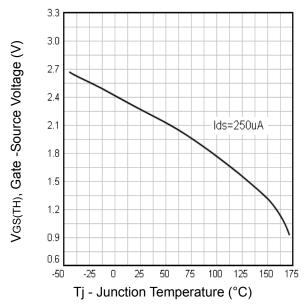


Fig9. Threshold Voltage Vs. Temperature

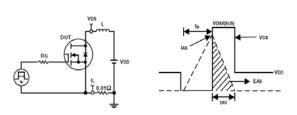


Fig11. Unclamped Inductive Test Circuit and waveforms

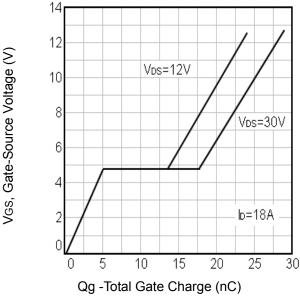


Fig8. Typical Gate Charge Vs.Gate-Source Voltage

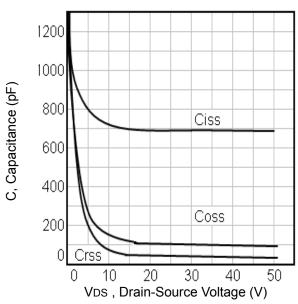


Fig10. Typical Capacitance Vs.Drain-Source Voltage

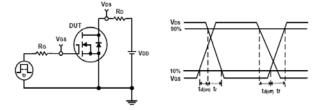


Fig12. Switching Time Test Circuit and waveforms



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